

SPECIFICATION



Approval

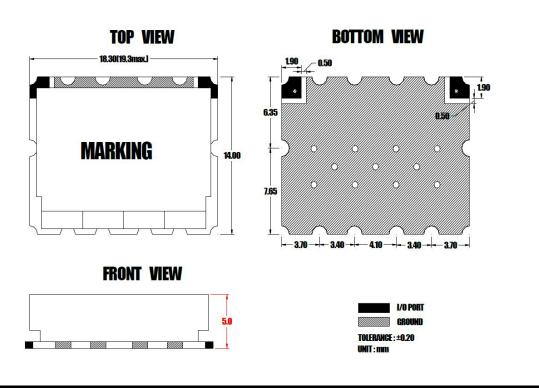
CK Chang

Part No.:	Written by	Checked by
Customer:	FL Lai	DU liona
Date: 2019.12.04	FL Lai	PH Jiang

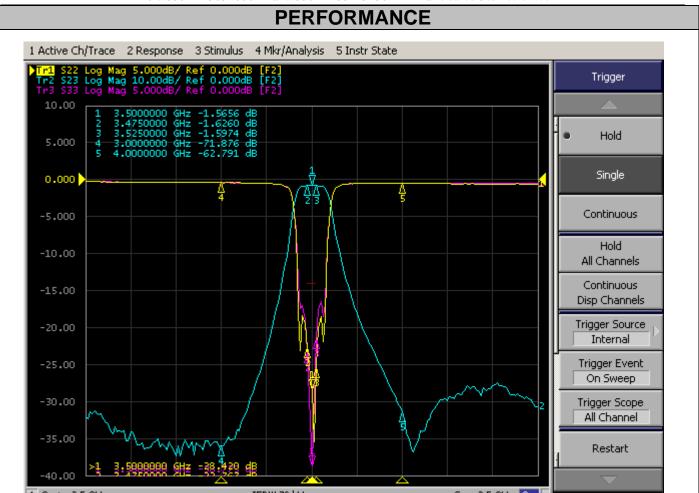
Lot No.: 20190180-3

ELECTRICAL SPECIFICATIONS				
ITEN	TEM SPEC		UNIT	
1	Center freq	3500.0		
2	Bandwidth [BW]	fo ±25.0 [3475.0~3525.0]	min MHz	
3	Insertion Loss in BW	2.0 in regular temp	dB max.	
4	Ripple in BW	0.5 in regular temp	dB max.	
5	Return Loss in BW		dB min.	
6	V S W R in BW	1.5 in regular temp	max.	
7	Attenuation (Absolute Value)	70.0 dB min. @ fo ± [3000.0 &] 40.0 dB min. @ fo ± [4000.0 &] 60.0 dB min. @ fo ± [6000.0 &] 70.0 dB min. @ fo ± [500.0 &]	MHz	
8	Input Power	max	W	
9	In/Out Impedance	50.0	Ω	
10	Operation Temperature Range	-40°C to +70°C	°C	

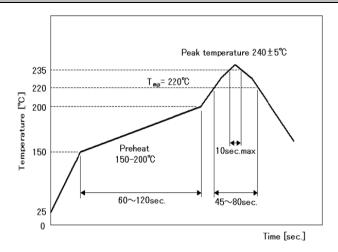
MECHANICAL SPECIFICATIONS



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SOLDERING CONDITION



Remark:

- Please ensure that the good grounding (ground and I/O part area). When the product is used, in order to ensure good grounding ,bottom area after soldering, that need for the side pin to repair welding.
- 2. Product recommended using SMT process, the above is recommended reflow temperature curve. Because of different substrate and reflow soldering equipment varies, according to the substrate and reflow soldering equipment to confirm the actual temperature curve.
- 3. If special occasion occurs which needs manual soldering, the temperature should be 350°C, but not Over 3 times, and reflow and manual soldering should not be over 3 times.